

**PRODUCT FEATURES**

- High level of integration
- 600V IGBT<sup>3</sup> CHIP(Trench+Field Stop technology)
- Low saturation voltage and positive temperature coefficient
- Fast switching and short tail current
- Free wheeling diodes with fast and soft reverse recovery
- Industry standard package with insulated copper base plate and soldering pins for PCB mounting
- Temperature sense included

**APPLICATIONS**

- AC motor control
- Motion/servo control
- Inverter and power supplies

Rectifier+Brake+Inverter**IGBT-inverter****ABSOLUTE MAXIMUM RATINGS( $T_c=25^\circ\text{C}$  unless otherwise specified)**

Symbol	Parameter/Test Conditions		Values	Unit
$V_{CES}$	Collector Emitter Voltage	$T_J=25^\circ\text{C}$	600	V
$V_{GES}$	Gate Emitter Voltage		$\pm 20$	
$I_C$	DC Collector Current	$T_c=25^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	125	A
		$T_c=70^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	100	
$I_{CM}$	Repetitive Peak Collector Current	$t_p=1\text{ms}$	200	
$P_{tot}$	Power Dissipation Per IGBT	$T_c=25^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	330	W

**Diode-inverter****ABSOLUTE MAXIMUM RATINGS ( $T_c=25^\circ\text{C}$  unless otherwise specified)**

Symbol	Parameter/Test Conditions		Values	Unit
$V_{RRM}$	Repetitive Reverse Voltage	$T_J=25^\circ\text{C}$	600	V
$I_{F(AV)}$	Average Forward Current		100	
$I_{FRM}$	Repetitive Peak Forward Current	$t_p=1\text{ms}$	200	A
$I^2t$		$T_J=125^\circ\text{C}, t=10\text{ms}, V_R=0\text{V}$	1000	

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# MMG100W060XB6TC

IGBT-inverter

ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit	
$V_{GE(\text{th})}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}$ , $I_C=1.6\text{mA}$	5.0	5.8	6.5	V	
$V_{CE(\text{sat})}$	Collector Emitter Saturation Voltage	$I_C=100\text{A}$ , $V_{GE}=15\text{V}$ , $T_J=25^\circ\text{C}$		1.5	1.9		
		$I_C=100\text{A}$ , $V_{GE}=15\text{V}$ , $T_J=125^\circ\text{C}$		1.7			
		$I_C=100\text{A}$ , $V_{GE}=15\text{V}$ , $T_J=150^\circ\text{C}$		1.75			
$I_{CES}$	Collector Leakage Current	$V_{CE}=600\text{V}$ , $V_{GE}=0\text{V}$ , $T_J=25^\circ\text{C}$			1	mA	
		$V_{CE}=600\text{V}$ , $V_{GE}=0\text{V}$ , $T_J=150^\circ\text{C}$			5	mA	
$I_{GES}$	Gate Leakage Current	$V_{CE}=0\text{V}$ , $V_{GE}=\pm 20\text{V}$ , $T_J=25^\circ\text{C}$	-400		400	nA	
$R_{Gint}$	Integrated Gate Resistor			2		$\Omega$	
$Q_G$	Gate Charge	$V_{CE}=300\text{V}$ , $I_C=100\text{A}$ , $V_{GE}=15\text{V}$		0.58		$\mu\text{C}$	
$C_{ies}$	Input Capacitance	$V_{CE}=25\text{V}$ , $V_{GE}=0\text{V}$ , $f=1\text{MHz}$		6.8		nF	
$C_{res}$	Reverse Transfer Capacitance			300		pF	
$t_{d(on)}$	Turn on Delay Time	$V_{CC}=300\text{V}$ , $I_C=100\text{A}$ , $R_G=5.1\Omega$ , $V_{GE}=\pm 15\text{V}$ , Inductive Load	$T_J=25^\circ\text{C}$	35		ns	
			$T_J=150^\circ\text{C}$	45		ns	
$t_r$	Rise Time		$T_J=25^\circ\text{C}$	40		ns	
			$T_J=150^\circ\text{C}$	45		ns	
$t_{d(off)}$	Turn off Delay Time	$V_{CC}=300\text{V}$ , $I_C=100\text{A}$ , $R_G=5.1\Omega$ , $V_{GE}=\pm 15\text{V}$ , Inductive Load	$T_J=25^\circ\text{C}$	220		ns	
			$T_J=150^\circ\text{C}$	260		ns	
$t_f$	Fall Time		$T_J=25^\circ\text{C}$	60		ns	
			$T_J=150^\circ\text{C}$	70		ns	
$E_{on}$	Turn on Energy	$V_{CC}=300\text{V}$ , $I_C=100\text{A}$ , $R_G=5.1\Omega$ , $V_{GE}=\pm 15\text{V}$ , Inductive Load	$T_J=25^\circ\text{C}$	2		mJ	
			$T_J=125^\circ\text{C}$	2.55		mJ	
			$T_J=150^\circ\text{C}$	2.75		mJ	
$E_{off}$	Turn off Energy		$T_J=25^\circ\text{C}$	1.6		mJ	
			$T_J=125^\circ\text{C}$	2.15		mJ	
			$T_J=150^\circ\text{C}$	2.25		mJ	
$I_{sc}$	Short Circuit Current	$t_{psc} \leq 6\mu\text{s}$ , $V_{GE}=15\text{V}$ , $T_J=125^\circ\text{C}$ , $V_{CC}=360\text{V}$		500		A	
$R_{thJC}$	Junction to Case Thermal Resistance ( Per IGBT )				0.46	K/W	

Diode-inverter

ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$V_F$	Forward Voltage	$I_F=100\text{A}$ , $V_{GE}=0\text{V}$ , $T_J=25^\circ\text{C}$		1.75	2.2	V
		$I_F=100\text{A}$ , $V_{GE}=0\text{V}$ , $T_J=125^\circ\text{C}$		1.65		
		$I_F=100\text{A}$ , $V_{GE}=0\text{V}$ , $T_J=150^\circ\text{C}$		1.60		
$t_{rr}$	Reverse Recovery Time	$I_F=100\text{A}$ , $V_R=300\text{V}$ , $dI_F/dt=-4150\text{A}/\mu\text{s}$ , $T_J=150^\circ\text{C}$		100		ns
$I_{RRM}$	Max. Reverse Recovery Current			140		A
$Q_{RR}$	Reverse Recovery Charge	$T_J=150^\circ\text{C}$		11		$\mu\text{C}$
$E_{rec}$	Reverse Recovery Energy			3.1		mJ
$R_{thJCD}$	Junction to Case Thermal Resistance ( Per Diode )				0.8	K/W

# MMG100W060XB6TC

## Diode-RECTIFIER

### ABSOLUTE MAXIMUM RATINGS ( $T_c = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
$V_{RRM}$	Repetitive Reverse Voltage	$T_J=25^\circ\text{C}$	1600	V
$I_{F(AV)}$	Average Forward Current Per Diode	$T_c=80^\circ\text{C}$	80	A
$I_{FRMS}$	R.M.S. Forward Current Per Diode		125	
$I_{RMS}$	R.M.S. Current at rectifier output		150	
$I_{FSM}$	Non Repetitive Surge Forward Current	$T_J=45^\circ\text{C}$ , $t=10\text{ms}$ , 50Hz	1050	
		$T_J=45^\circ\text{C}$ , $t=8.3\text{ms}$ , 60Hz	1151	
$I^2t$		$T_J=45^\circ\text{C}$ , $t=10\text{ms}$ , 50Hz	5510	$\text{A}^2\text{s}$
		$T_J=45^\circ\text{C}$ , $t=8.3\text{ms}$ , 60Hz	5508	

## Diode-RECTIFIER

### ELECTRICAL CHARACTERISTICS ( $T_c = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$V_F$	Forward Voltage	$I_F=100\text{A}$ , $T_J=25^\circ\text{C}$		1.1	1.3	V
		$I_F=100\text{A}$ , $T_J=150^\circ\text{C}$		1.04		V
$I_R$	Reverse Leakage Current	$V_R=1600\text{V}$ , $T_J=25^\circ\text{C}$			50	$\mu\text{A}$
		$V_R=1600\text{V}$ , $T_J=150^\circ\text{C}$			1	mA
$R_{thJCD}$	Junction to Case Thermal Resistance ( Per Diode)				0.46	K /W

## IGBT-Brake chopper

### ABSOLUTE MAXIMUM RATINGS ( $T_c = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
$V_{CES}$	Collector Emitter Voltage	$T_J=25^\circ\text{C}$	600	V
$V_{GES}$	Gate Emitter Voltage		$\pm 20$	
$I_C$	DC Collector Current	$T_c=25^\circ\text{C}$ , $T_{Jmax}=175^\circ\text{C}$	95	A
		$T_c=70^\circ\text{C}$ , $T_{Jmax}=175^\circ\text{C}$	75	
$I_{CM}$	Repetitive Peak Collector Current	$t_p=1\text{ms}$	150	
$P_{tot}$	Power Dissipation Per IGBT	$T_c=25^\circ\text{C}$ , $T_{Jmax}=175^\circ\text{C}$	250	W

## Diode-Brake chopper

### ABSOLUTE MAXIMUM RATINGS ( $T_c = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
$V_{RRM}$	Repetitive Reverse Voltage	$T_J=25^\circ\text{C}$	600	V
$I_{F(AV)}$	Average Forward Current		50	A
$I_{FRM}$	Repetitive Peak Forward Current	$t_p=1\text{ms}$	100	
$I^2t$		$T_J=125^\circ\text{C}$ , $t=10\text{ms}$ , $V_R=0\text{V}$	392	$\text{A}^2\text{s}$

# MMG100W060XB6TC

IGBT-Brake chopper

ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit	
$V_{GE(\text{th})}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}$ , $I_C=1.2\text{mA}$	5.0	5.8	6.5	V	
$V_{CE(\text{sat})}$	Collector Emitter Saturation Voltage	$I_C=75\text{A}$ , $V_{GE}=15\text{V}$ , $T_J=25^\circ\text{C}$		1.55	2.0		
		$I_C=75\text{A}$ , $V_{GE}=15\text{V}$ , $T_J=125^\circ\text{C}$		1.75			
		$I_C=75\text{A}$ , $V_{GE}=15\text{V}$ , $T_J=150^\circ\text{C}$		1.80			
$I_{CES}$	Collector Leakage Current	$V_{CE}=600\text{V}$ , $V_{GE}=0\text{V}$ , $T_J=25^\circ\text{C}$			1	mA	
		$V_{CE}=600\text{V}$ , $V_{GE}=0\text{V}$ , $T_J=150^\circ\text{C}$			10	mA	
$I_{GES}$	Gate Leakage Current	$V_{CE}=0\text{V}$ , $V_{GE}=\pm 15\text{V}$ , $T_J=25^\circ\text{C}$	-400		400	nA	
$R_{Gint}$	Integrated Gate Resistor			0		$\Omega$	
$Q_G$	Gate Charge	$V_{CE}=300\text{V}$ , $I_C=75\text{A}$ , $V_{GE}=\pm 15\text{V}$		0.36		$\mu\text{C}$	
$C_{ies}$	Input Capacitance	$V_{CE}=25\text{V}$ , $V_{GE}=0\text{V}$ , $f=1\text{MHz}$		4.8		nF	
$C_{res}$	Reverse Transfer Capacitance			200		pF	
$t_{d(on)}$	Turn on Delay Time	$V_{CC}=300\text{V}$ , $I_C=75\text{A}$ $R_G=5.1\Omega$ , $V_{GE}=\pm 15\text{V}$ , Inductive Load	$T_J=25^\circ\text{C}$		20	ns	
			$T_J=150^\circ\text{C}$		25	ns	
$t_r$	Rise Time		$T_J=25^\circ\text{C}$		30	ns	
			$T_J=150^\circ\text{C}$		32	ns	
$t_{d(off)}$	Turn off Delay Time	$V_{CC}=300\text{V}$ , $I_C=75\text{A}$ $R_G=5.1\Omega$ , $V_{GE}=\pm 15\text{V}$ , Inductive Load	$T_J=25^\circ\text{C}$		190	ns	
			$T_J=150^\circ\text{C}$		230	ns	
$t_f$	Fall Time		$T_J=25^\circ\text{C}$		60	ns	
			$T_J=150^\circ\text{C}$		70	ns	
$E_{on}$	Turn on Energy	$V_{CC}=300\text{V}$ , $I_C=75\text{A}$ $R_G=5.1\Omega$ , $V_{GE}=\pm 15\text{V}$ , Inductive Load	$T_J=25^\circ\text{C}$		0.66	mJ	
			$T_J=125^\circ\text{C}$		0.88	mJ	
			$T_J=150^\circ\text{C}$		0.93	mJ	
$E_{off}$	Turn off Energy		$T_J=25^\circ\text{C}$		1.6	mJ	
			$T_J=125^\circ\text{C}$		2.15	mJ	
			$T_J=150^\circ\text{C}$		2.25	mJ	
$I_{sc}$	Short Circuit Current	$t_{psc} \leq 6\mu\text{s}$ , $V_{GE}=15\text{V}$ $T_J=150^\circ\text{C}$ , $V_{CC}=360\text{V}$		400		A	
$R_{thJC}$	Junction to Case Thermal Resistance ( Per IGBT )				0.6	K/W	

Diode-Brake chopper

ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$V_F$	Forward Voltage	$I_F=50\text{A}$ , $V_{GE}=0\text{V}$ , $T_J=25^\circ\text{C}$		1.90	2.30	V
		$I_F=50\text{A}$ , $V_{GE}=0\text{V}$ , $T_J=125^\circ\text{C}$		1.75		
		$I_F=50\text{A}$ , $V_{GE}=0\text{V}$ , $T_J=150^\circ\text{C}$		1.70		
$I_{RRM}$	Max. Reverse Recovery Current	$I_F=50\text{A}$ , $V_R=300\text{V}$ $dI_F/dt=-1000\text{A}/\mu\text{s}$ $T_J=150^\circ\text{C}$		30		A
$Q_{RR}$	Reverse Recovery Charge			2.85		$\mu\text{C}$
$E_{rec}$	Reverse Recovery Energy			0.6		mJ
$R_{thJCD}$	Junction to Case Thermal Resistance ( Per Diode )				1.3	K/W

# MMG100W060XB6TC

**NTC CHARACTERISTICS ( $T_c = 25^\circ\text{C}$  unless otherwise specified)**

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$R_{25}$	Resistance	$T_c = 25^\circ\text{C}$		5		$\text{k}\Omega$
$B_{25/50}$	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298.15 \text{ K}))]$			3375		K

**MODULE CHARACTERISTICS ( $T_c = 25^\circ\text{C}$  unless otherwise specified)**

Symbol	Parameter/Test Conditions	Values	Unit
$T_{Jmax}$	Max. Junction Temperature	Inverter, Brake-Chopper	175
		Rectifier	150
$T_{Jop}$	Operating Temperature	-40~150	$^\circ\text{C}$
$T_{stg}$	Storage Temperature	-40~125	
$V_{isol}$	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute	3000
CTI	Comparative Tracking Index	>200	
Md	Mounting Torque	Recommended (M5)	2.5~5
Weight		300	g

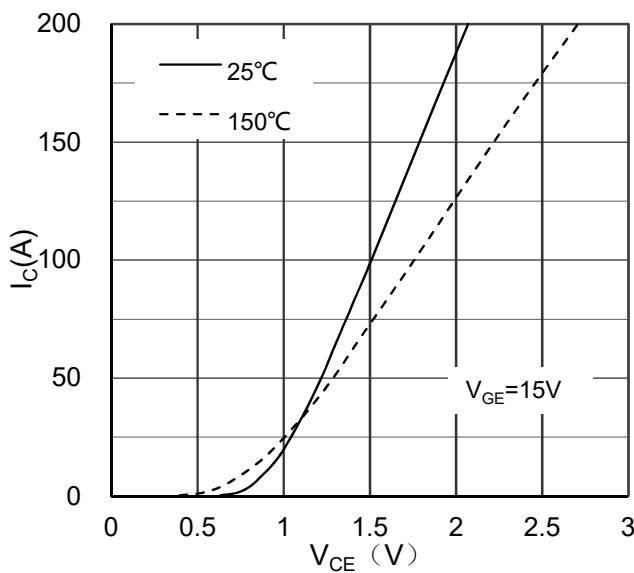


Figure 1. Typical Output Characteristics IGBT-inverter

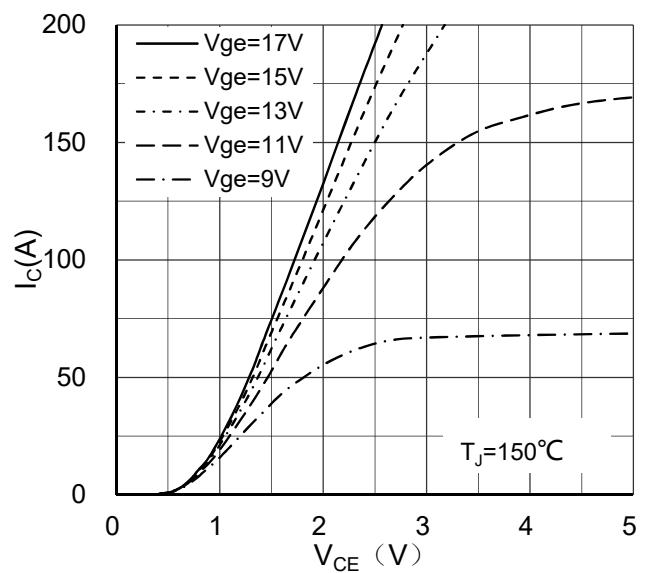


Figure 2. Typical Output Characteristics IGBT-inverter

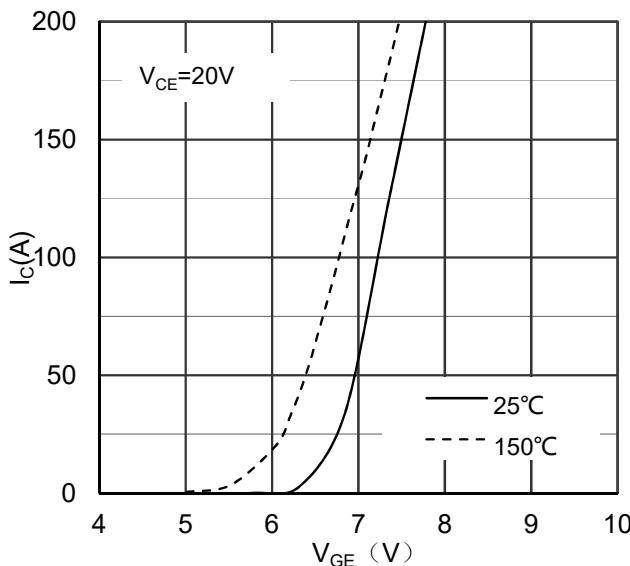


Figure 3. Typical Transfer characteristics IGBT-inverter

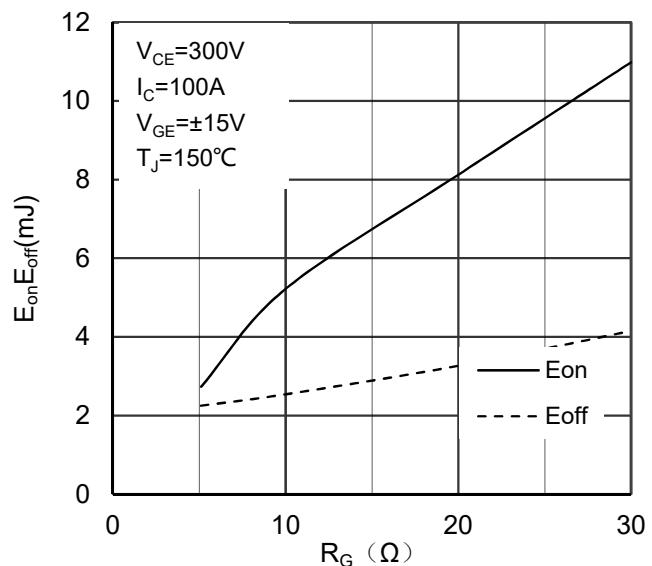


Figure 4. Switching Energy vs Gate Resistor IGBT-inverter

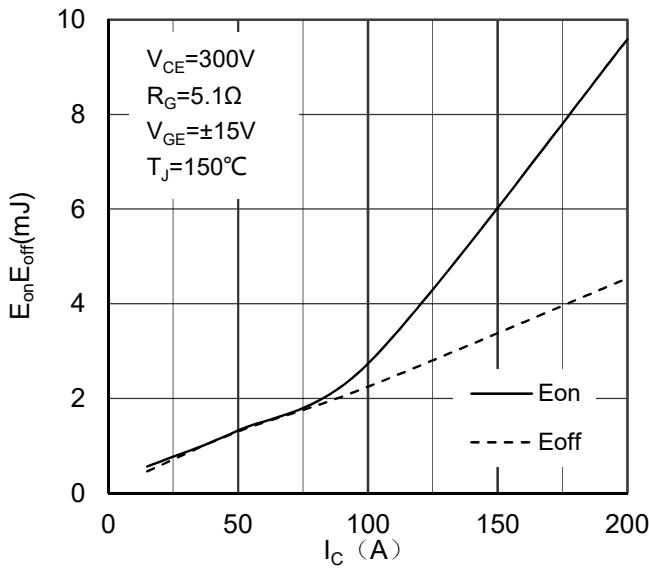


Figure 5. Switching Energy vs Collector Current IGBT-inverter

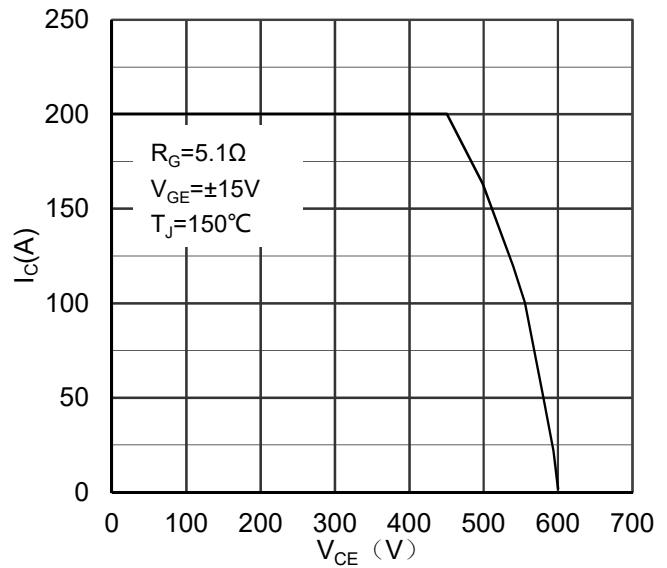


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

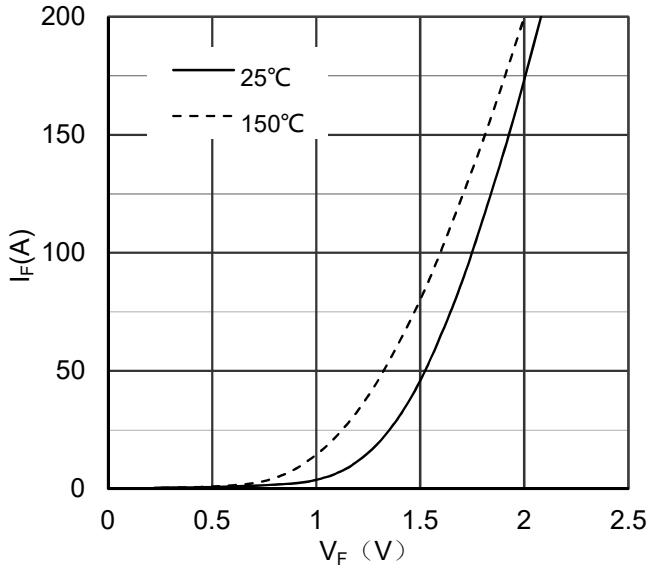


Figure 7. Diode Forward Characteristics Diode -inverter

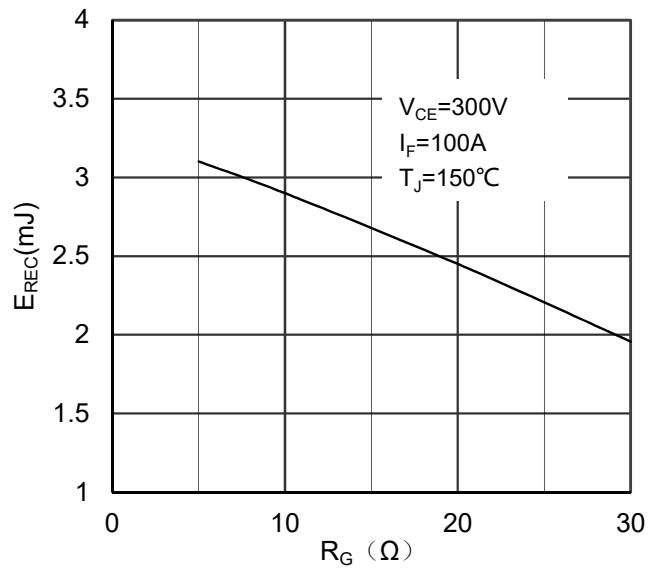


Figure 8. Switching Energy vs Gate Resistor Diode -inverter

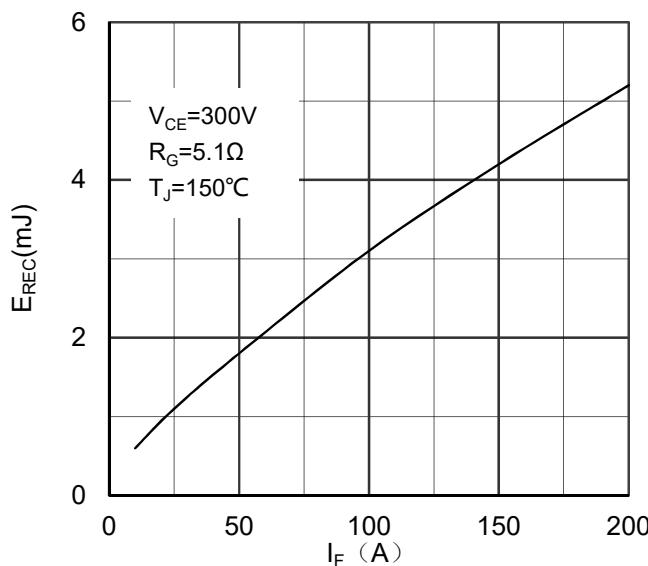


Figure 9. Switching Energy vs Forward Current Diode-inverter

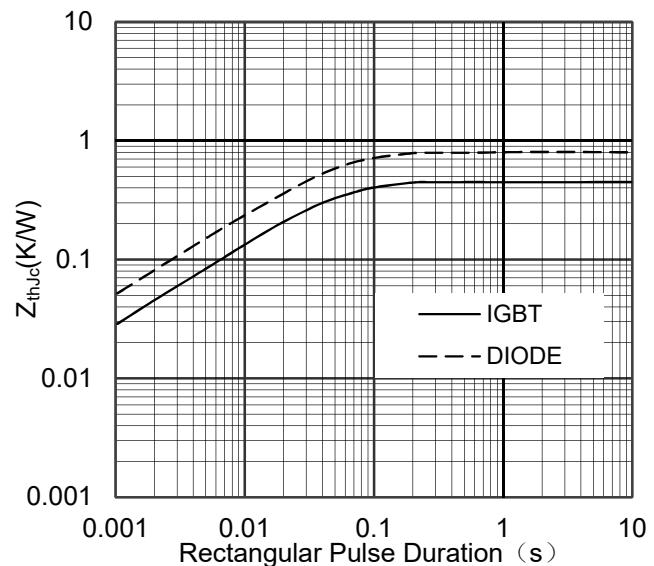


Figure 10. Transient Thermal Impedance of Diode and IGBT-inverter

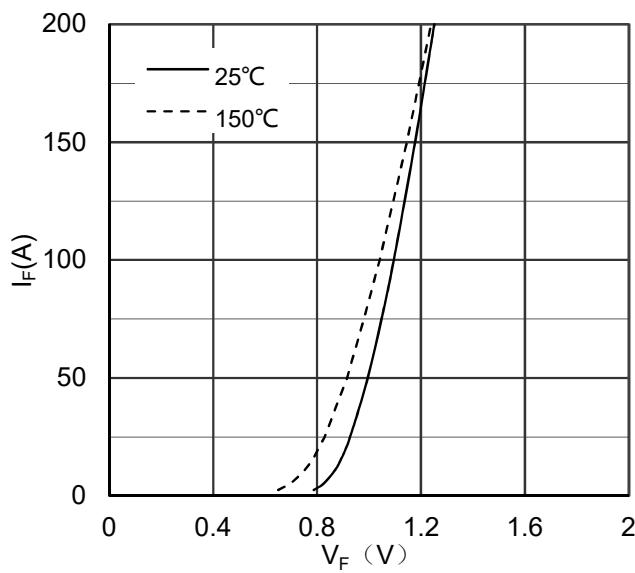


Figure 11. Diode Forward Characteristics Diode- rectifier

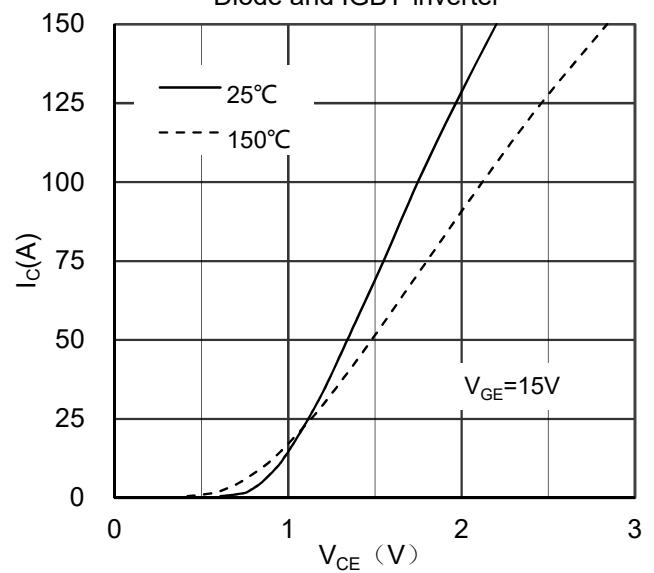


Figure 12. Typical Output Characteristics IGBT- brake chopper

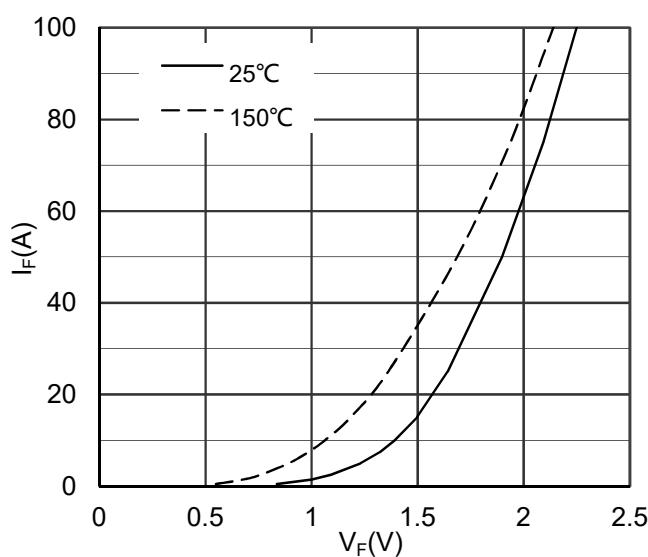


Figure 13. Diode Forward Characteristics Diode - brake chopper

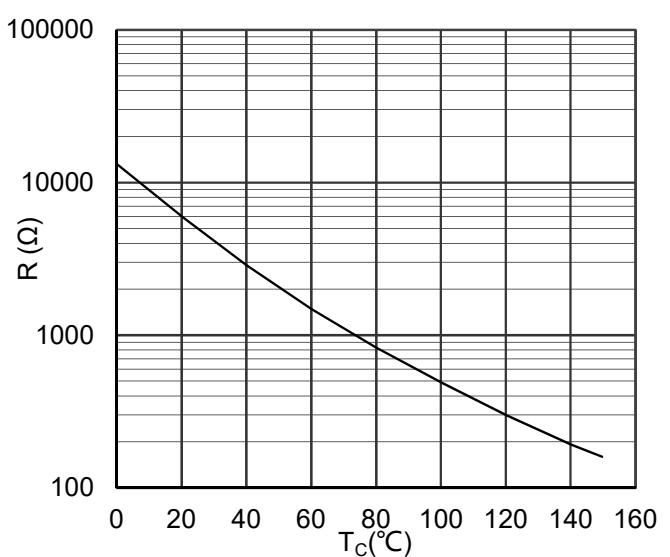


Figure 14. NTC Characteristics

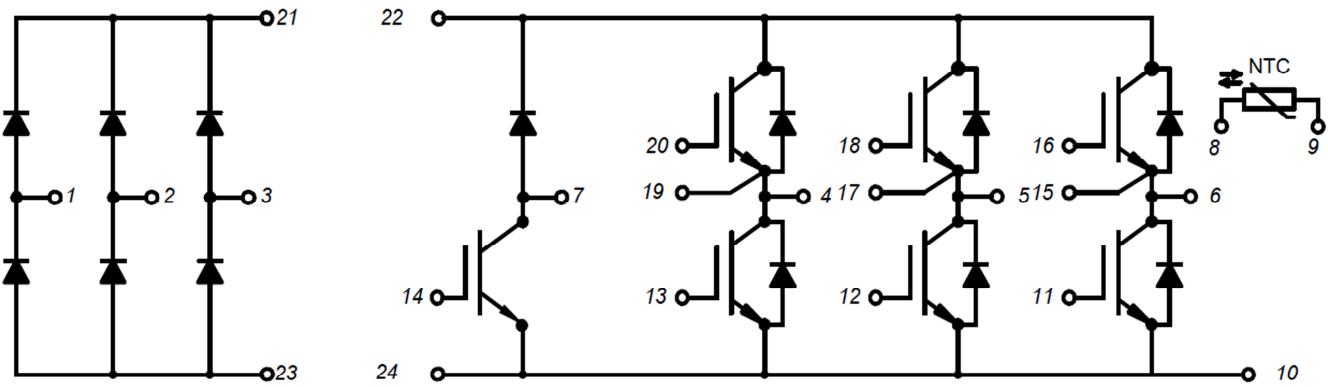
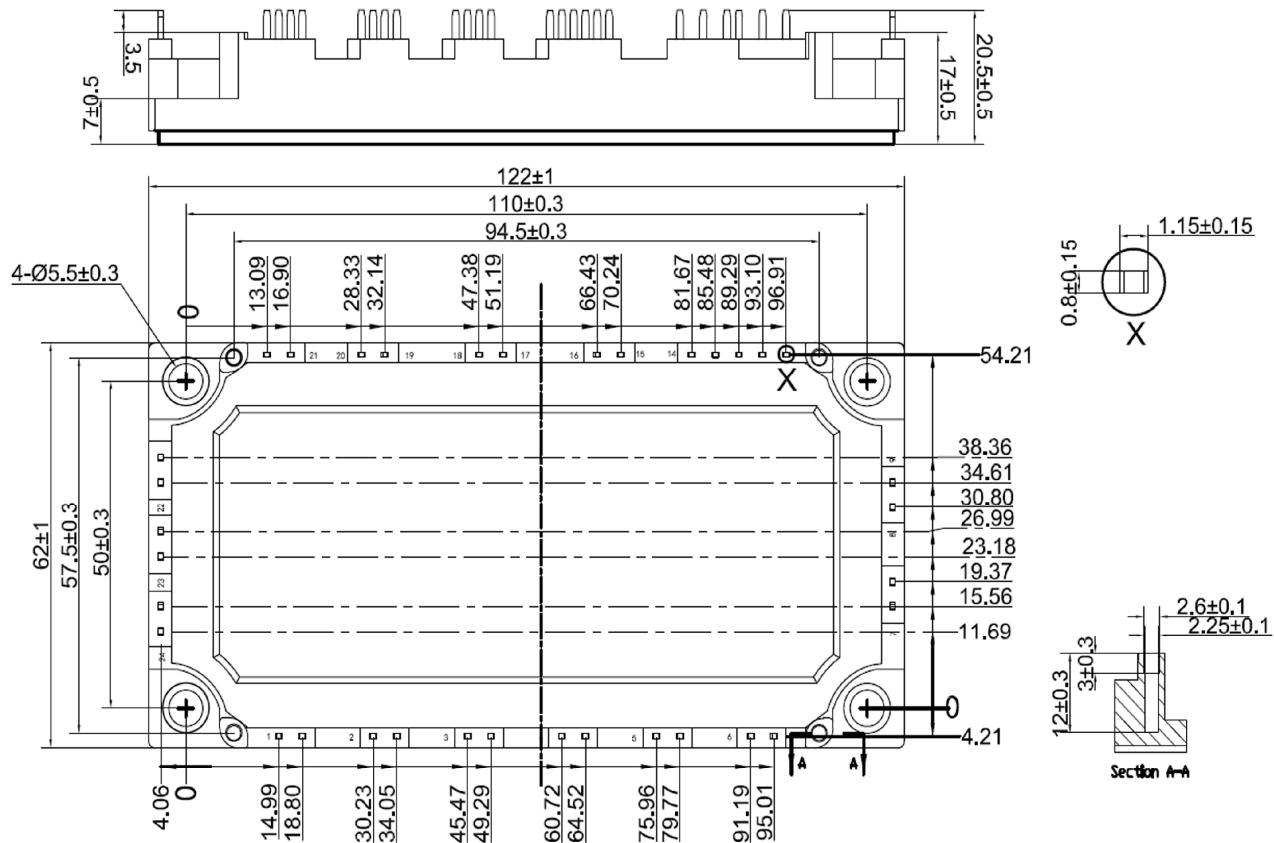


Figure 15. Circuit Diagram



Dimensions in (mm)

Figure 16. Package Outline